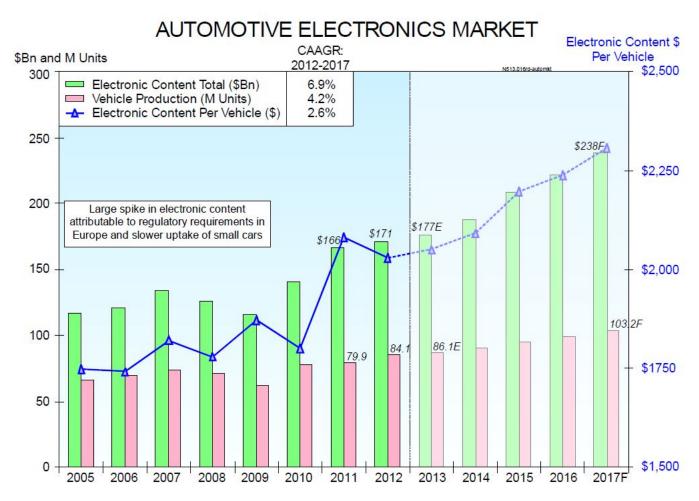
Advances in Automotive Electronics Soldering Technology

Traian C. Cucu, Ph.D.
Global Product Manager
Alpha, an Alent plc Company

Summary

- Automotive Market Growth
- Market Segmentation
- Automotive Market Trends
- Low Melting Point Solder for Automotive
- Future Developments
- Alpha Corporate Presentation

Overview



Macro Trends

Things finally getting smaller

 Rapid Miniaturisation for Some Newer Applications

- CSP's becoming common in infotainment, vision systems and other in-cabin applications:
 - o.5mm pitch CSP
 - o2o1 passives
 - o.4 pitch CSP for high end infotainment

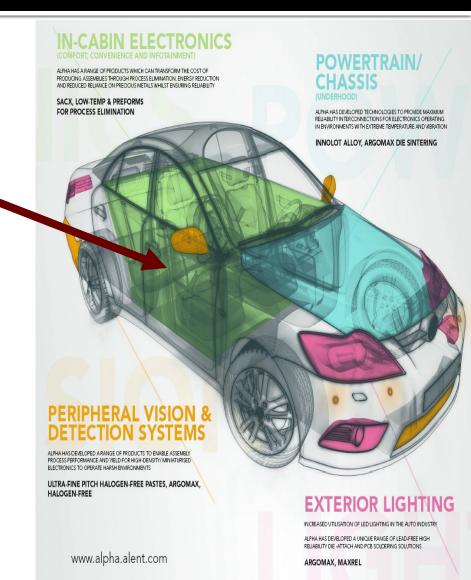
Low Melting Point Soldering Niche

Modules

- Instrumentation Power Distribution Seat Electronics Interior Lighting Audio/Infotainment

Focus Areas

- Lower cost / high yield alloys
- Low temperature alloys for non critical applications
- Wave Flimination for Connectors
 - Reduce Cost of Assembly
 - Reduced process defects
 - Reduction of EC failures from flux



In-Cabin Electronics

Comfort, Convenience and Infotainment

Key Drivers

- Total Cost of Ownership reduction
- Miniaturisation
- EC reliability under dewing conditions

Current Positioning

- Strong representation of SAC alloys (SAC305 SAC405)
- Lower Ag alloys have proved to be a good fit in certain applications, not yet widely introduced

Potential compelling value proposition

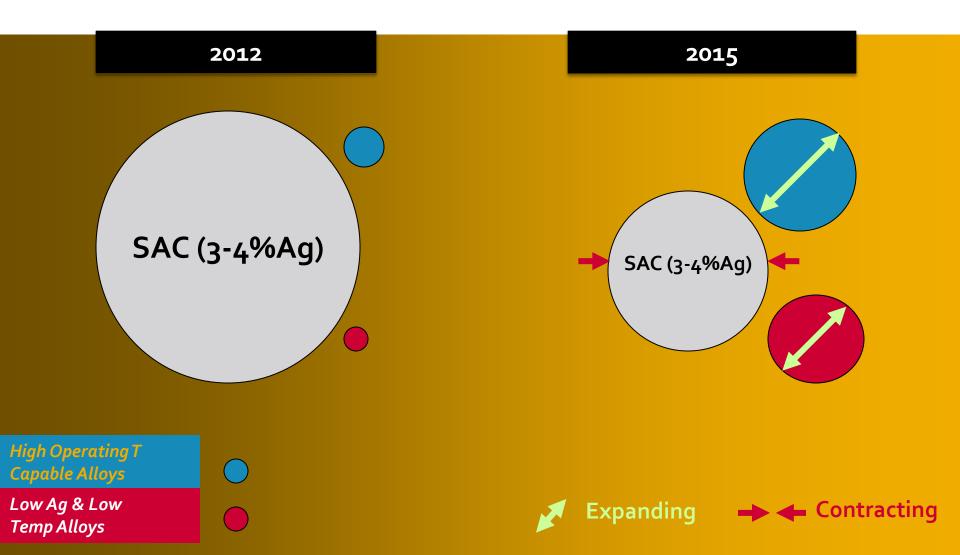
- Collaborative approach to enable switch to low Ag and low temperature and transition to the low temperature alloy processing
- The Total Cost of Ownership reduction makes it a compelling value



Macro Trends – Application Specific Alloy

- Trending to lower cost and/or higher performance
- SAC dominance to decrease
- Low Temperatures Alloys are presenting a compelling value (melting point around 138-140 °C, eutectic and non-eutectic alloys)
 - o SnBi Ag
 - o SBXo2 (no Ag alloy)

Macro Trends – Application Specific Alloy



Active Developments

- Development directions
 - New alloy development
 - improve mechanical properties of the solder bulk
 - New paste chemistry development
 - > enhance the mechanical properties of the joint

Next On - Alloys

217°C -227°C

- SAC alloys
- High mechanical reliability



- New alloys
- Improved mechanical reliability

Next On - Chemistries

- Improved mechanical reliability of the solder joint through chemistry
- Improve d electrical reliability of the assembly - SIR: IPC, Bellcore, JIS, Bono.....

About Alpha

- An Alent plc company
- Date of Origin: 1872
- Global Operations:
 - 21 Manufacturing Sites
 - 4 Research and Development Centers
 - Operations in 27+ Countries
 - 1,290 Employees
 - 2012 Sales: £439 m (\$707 m)

Key Markets



Sales Support in Every Major Electronics Mark



AMERICAS-USA

California Florida Georgia Illinois Mass. New Jersey Ohio

Pennsylvania

Texas

Ontario, Canada Guadalajara, Mexico Tijuana, Mexico Buenos Aires, Argentina Tierra del Fuego, Argentina Sao Paulo, Brazil Manaus, Brazil

EUROPE

Woking, England Turnhout, Belgium Cholet, France Langenfeld, Germany Budapest, Hungary Milano, Italy Naarden, Netherlands

ASIA-PACIFIC

Hong Kong, China Shenzhen, China Beijing, China Chengdu, China Nanjing, China Shanghai, China Suzhou, China Tianjin, China Xiamen, China Bangalore, India Chennai, India

Delhi, India Hyderabad, India Pune, India Hiratsuka, Japan Sihung City, Korea Penang, Malaysia Muntinlupa, Philippines Singapore Taoyuan, Taiwan Bangkok, Thailand Thomastown, Australia Auckland, New Zealand Vietnam

Customer Technical Support in Every Major Electronics Market



Buenos Aires, Argentina Tierra Del Fuego, Argentina

Sao Paulo, Brazil Manaus, Brazil

Turnhout, Belgium Cholet, France Langenfeld, Germany Bangalore, India Chennai, India

Singapore Taoyuan, Taiwan

Manufacturing Sites

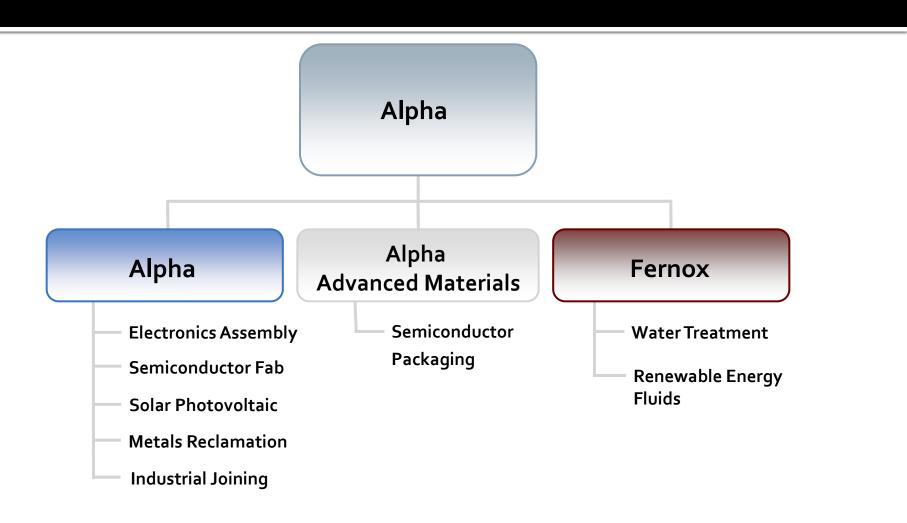
Multiple Sites to Ensure Continuity of Supply



Illinois, USA Pennsylvania, USA Mexico City, Mexico Monterrey, Mexico Manaus, Brazil Sao Paulo, Brazil

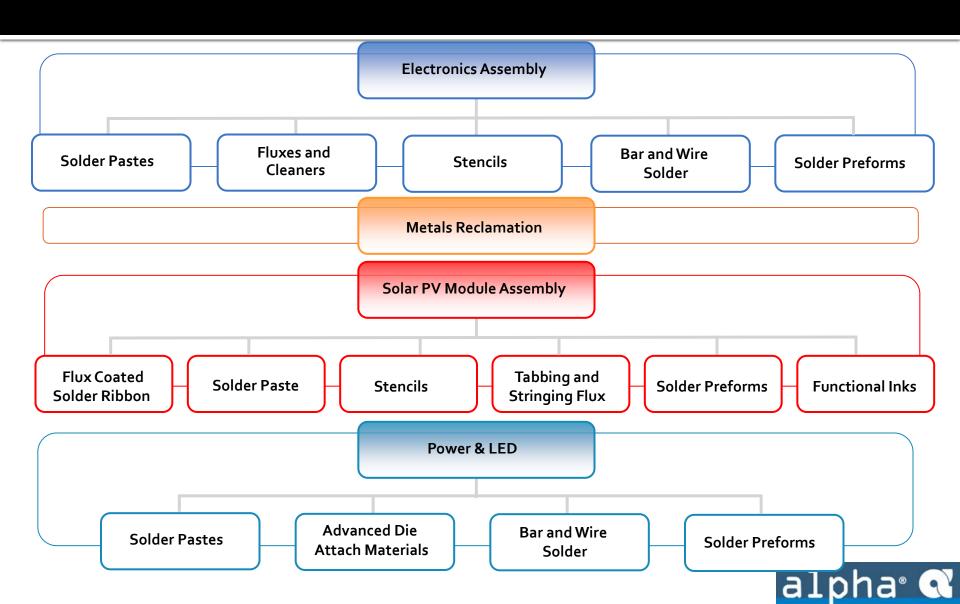
Woking, England Turnhout, Belgium Cholet, France Budapest, Hungary 's-Hertogenbosch, The Netherlands Naarden, The Netherlands Hong Kong, China Guangxi, China Shenzhen, China Shanghai, China Chennai, India Hiratsuka, Japan Sihung City, Korea Singapore Taoyuan, Taiwan

Markets Lines by Business





Key Product Lines by Market



Management Systems (QMS, EMS, OH&S)

- A Global electronic Quality Management System (eQMS) is installed at every Alpha site to manage documents and Quality activities, including Environmental Management System (EMS) and Occupational Health and Safety (OH&S) systems via a single Registrar, BSI.
- All Alpha manufacturing facilities have direct lot traceability for manufactured products through a global ERP system (JDE), SOP's, and WinLIMS (i.e. Operators, Intermediate Components, Raw Materials).
- Alpha's manufacturing facilities are all QMS certified. Listed below are the number of Management System certifications via a single Registrar, BSI.

ISO 9001: 26 Facilities (Regional Certifications)

ISO/TS 16949: 3 Mfg. Facilities & 2 Supporting R&D Centers

ISO 14001: 18 Mfg. Facilities

OHSAS 18001: 13 Mfg. Facilities (and growing)



alpha 🗨

OHSAS 1800

Alpha Research and Development

- Integrated Worldwide Product and Technology Development
- 98 Scientists & Engineers (Alpha/AAM/Fernox)
- 26 PhD graduates
- Regional R&D Laboratories
 - US (2), India, Japan, Singapore
- 500+ Patents
- Excellent Technical Capability
 - Analytical & Diagnostic Labs
 - CPM Analytics (US and Bangalore)
 - Extensive Electronic Assembly Line Assets (US, India, Japan)
 - University Alliances/Collaborations Worldwide (Oxford, IISc, Auburn and others)











Global Research and Development Laboratories



Alpha Vision Statement

"We will be the industry's preferred supplier of highperformance materials and chemistry by delivering leading technology...represented by our innovative products,

processes and people."





THANKYOU!